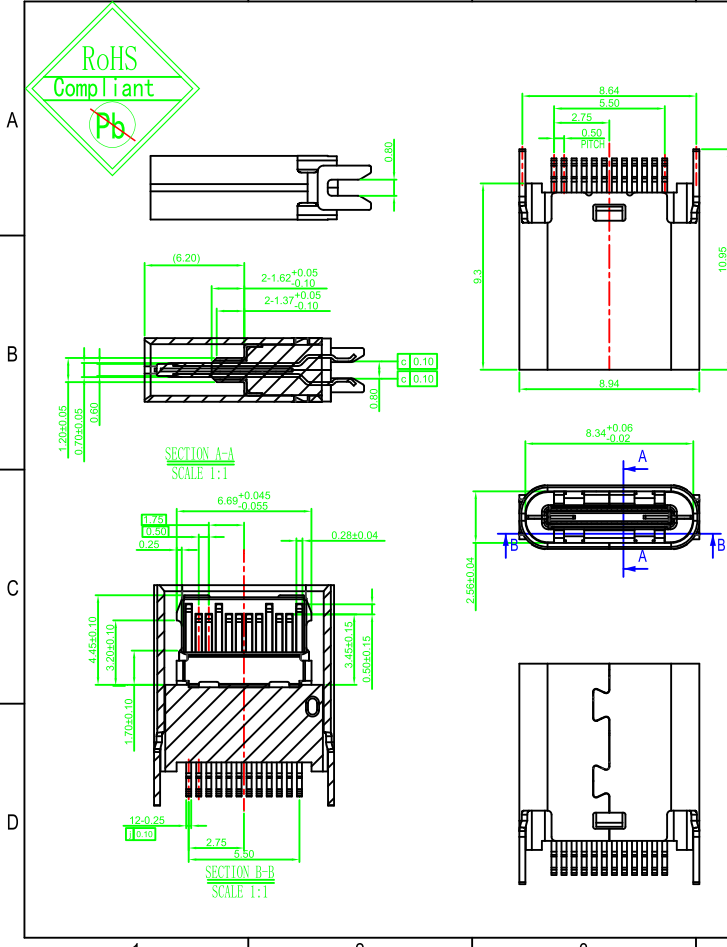
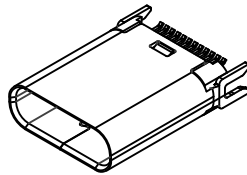


NOTES:

- 1.MATERIAL:
MOLDING: LCP UL94 V-0
CONTACT: COPPER ALLOY.
GOLD PLATING ALL OVER 50u" Min NICKEL
AND 100u" Min Tin ALL OVER 50u" Min NICKEL
ON SOLDER AREA
SHELL: SUS304-H, T=0.30±0.03mm
50u" NICKEL PLATING OVER ALL.
SHILD: SUS304-H, T=0.12±0.03mm
- 2.MECHANICAL:
INSERTION: 5~20N.
EXTRACTION: 8~20N.
DURABILITY: 10000 CYCLES
- 3.ELECTRICAL:
CURRENT: 5A MIN FOR VBUS;
0.25A MIN FOR OTHER.
VOLTAGE: 5VAC MAX
WITHSTANDING VOLTAGE: 100V AC.
CONTACT RESISTANCE: 40mΩ MAX.
INSULATION RESISTANCE: 100MΩ MIN.
- 4.ENVIRONMENTAL
TEMPERATURE RANGE -55°C ~ +85°C



UNITS mm	SCALE 1:1	REV. B3	SHEET 1 OF 1		
		DATE 2015.03.25	TITLE USB 3.1 C TYPE 夹板0.8MM(L=9.30mm)		
GENERAL TOLERANCE 0. ±0.30 0.0 ±0.20 0.00 ±0.15 0° ±4° 0.0° ±2°		DR. Andy.Pi	MAT'L SEE TABLE	FINISH SEE TABLE	
		APPD. zhufagui	DWG.NO.	A	PART NO. SEE TABLE
				SIZE A4	